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October 9, 2026

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(Securities code: 4187; Tokyo Stock Exchange, Prime Market)
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Partial Modification to Notice Concerning Acquisition of Fixed Asset (Construction of New Facility)

OSAKA ORGANIC CHEMICAL INDUSTRY LTD. (the "Company") hereby announces that the Company has resolved, at a meeting of the Board of Directors held today, to modify part of the "Notice Concerning Construction of New Facility for Semiconductor-related Materials" disclosed on December 22, 2025. The changes are underlined.

1. Description of changes

Overview of the new facility construction plan

(Before modification)

Products to be Manufactured	Semiconductor-related products
Location	157-23 Azashigerimatsu, Fujisaki, Yuza-machi, Akumi-gun, Yamagata
Scheduled Commencement/Completion	Scheduled to commence in 2026 / complete in 2028
Capital Investment	Approximately 10.0 billion yen

(After modification)

Products to be Manufactured	Semiconductor-related products
Location	157-23 Azashigerimatsu, Fujisaki, Yuza-machi, Akumi-gun, Yamagata
Scheduled Commencement/Completion	Scheduled to commence in 2027 / complete in 2029
Capital Investment	Approximately 20.0 billion yen

2. Reasons for modification

Considering the results from reassessing the details of the equipment to be installed aimed at expanding production capacity and improving high-purity processing technology based on the most recent demand simulations in addition to increasing construction material and equipment prices, the projected investment is expected to exceed the initially planned amount.

Furthermore, following a review of the construction timeline to deal with changes to the scope of equipment to be installed, the scheduled commencement and completion dates have also been revised.

3. Background and Investment Objectives

The semiconductor market is expected to continue to grow, driven by the advancement of AI technology and high-performance devices. Development of materials which support miniaturization and high-density integration as well as establishment of a stable supply system have become even more significant.

The Company, according to the medium-term management plan Progress & Development 2030 (covering the period from fiscal year ended November 30, 2024 to fiscal year ending November 30, 2030), has strengthened the development and production system of cutting-edge semiconductor materials through the construction of a medium-scale laboratory and the operation of manufacturing facilities, in which approximately 8.0 billion yen has been invested.

The Company aims to enhance production capacity and advance high-purity technology through this new facility construction plan, thereby expanding its market share in cutting-edge semiconductor materials and promoting business growth. The plan also aims to ensure business continuity by enabling dual-site production at the Kanazawa and Sakata Plants, further promoting the establishment of a stable supply system.

4. Future Outlook

The new facility under this investment is scheduled to be completed in 2029, and therefore its impact on the consolidated results for the fiscal year under review will be immaterial. If any events requiring disclosure occur in the future, we will make an announcement promptly.